

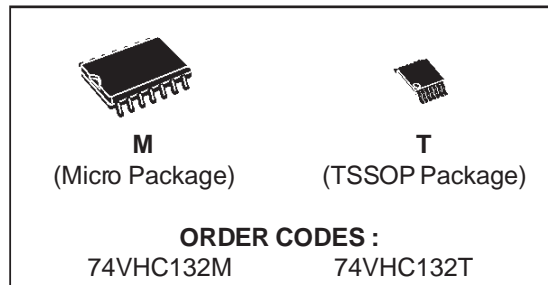
## QUAD 2-INPUT SCHMITT NAND GATE

- HIGH SPEED:  $t_{PD} = 4.9 \text{ ns}$  (TYP.) at  $V_{CC} = 5V$
- LOW POWER DISSIPATION:  
 $I_{CC} = 2 \mu\text{A}$  (MAX.) at  $T_A = 25 \text{ }^\circ\text{C}$
- TYPICAL HYSTERESIS:  $V_h = 1V$  at  $V_{CC} = 4.5V$
- POWER DOWN PROTECTION ON INPUTS
- SYMMETRICAL OUTPUT IMPEDANCE:  
 $|I_{OH}| = I_{OL} = 8 \text{ mA}$  (MIN)
- BALANCED PROPAGATION DELAYS:  
 $t_{PLH} \cong t_{PHL}$
- OPERATING VOLTAGE RANGE:  
 $V_{CC}$  (OPR) = 2V to 5.5V
- PIN AND FUNCTION COMPATIBLE WITH  
 74 SERIES 132
- IMPROVED LATCH-UP IMMUNITY
- LOW NOISE:  $V_{OLP} = 0.8V$  (Max.)

### DESCRIPTION

The 74VHC132 is an advanced high-speed CMOS QUAD 2-INPUT SCHMITT NAND GATE fabricated with sub-micron silicon gate and double-layer metal wiring C<sup>2</sup>MOS technology. Power down protection is provided on all inputs and 0 to 7V can be accepted on inputs with no

### PRELIMINARY DATA



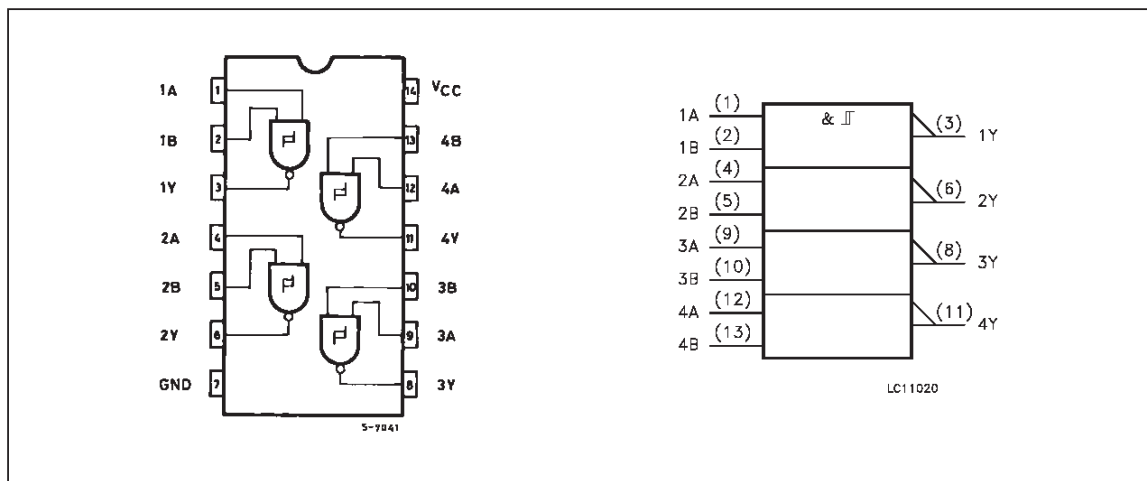
regard to the supply voltage. This device can be used to interface 5V to 3V.

Pin configuration and function are the same as those of the VHC00 but the VHC132 has hysteresis.

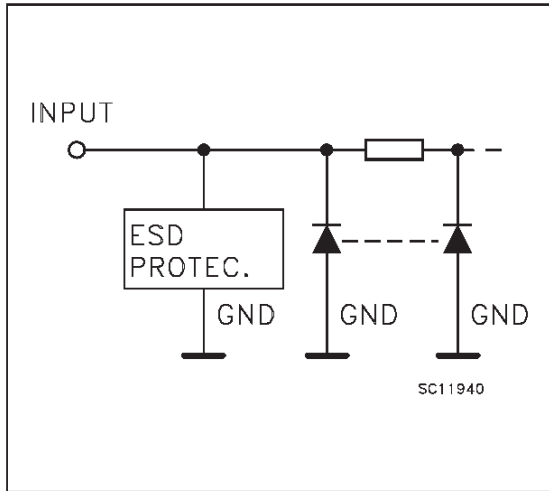
This together with its schmitt trigger function allows it to be used on line receivers with slow rise/fall input signals.

All inputs and outputs are equipped with protection circuits against static discharge, giving them 2KV ESD immunity and transient excess voltage.

### PIN CONNECTION AND IEC LOGIC SYMBOLS



## INPUT EQUIVALENT CIRCUIT



## PIN DESCRIPTION

PIN No	SYMBOL	NAME AND FUNCTION
1, 4, 9, 12	1A to 4A	Data Inputs
2, 5, 10, 13	1B to 4B	Data Inputs
3, 6, 8, 11	1Y to 4Y	Data Outputs
7	GND	Ground (0V)
14	V <sub>CC</sub>	Positive Supply Voltage

## TRUTH TABLE

A	B	Y
L	L	H
L	H	H
H	L	H
H	H	L

## ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply Voltage	-0.5 to +7.0	V
V <sub>I</sub>	DC Input Voltage	-0.5 to +7.0	V
V <sub>O</sub>	DC Output Voltage	-0.5 to V <sub>CC</sub> + 0.5	V
I <sub>IK</sub>	DC Input Diode Current	- 20	mA
I <sub>OK</sub>	DC Output Diode Current	± 20	mA
I <sub>O</sub>	DC Output Current	± 25	mA
I <sub>CC</sub> or I <sub>GND</sub>	DC V <sub>CC</sub> or Ground Current	± 50	mA
T <sub>stg</sub>	Storage Temperature	-65 to +150	°C
T <sub>L</sub>	Lead Temperature (10 sec)	300	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these condition is not implied.

## RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply Voltage	2.0 to 5.5	V
V <sub>I</sub>	Input Voltage	0 to 5.5	V
V <sub>O</sub>	Output Voltage	0 to V <sub>CC</sub>	V
T <sub>op</sub>	Operating Temperature	-40 to +85	°C

## DC SPECIFICATIONS

Symbol	Parameter	Test Conditions		Value					Unit	
				T <sub>A</sub> = 25 °C			-40 to 85 °C			
				V <sub>CC</sub> (V)	Min.	Typ.	Max.	Min.		Max.
V <sub>t+</sub>	High Level Threshold Voltage	3.0				2.2			V	
		4.5				3.15		3.15		
		5.5				3.85		3.85		
V <sub>t-</sub>	Low Level Threshold Voltage	3.0						0.9	0.9	
		4.5						1.35	1.35	
		5.5						1.65	1.65	
V <sub>h</sub>	Hysteresis Voltage	3.0				0.3		1.2	0.3	1.2
		4.5				0.4		1.4	0.4	1.4
		5.5				0.5		1.6	0.5	1.6
V <sub>OH</sub>	High Level Output Voltage	2.0	I <sub>O</sub> =-50 μA		1.9	2.0		1.9		
		3.0	I <sub>O</sub> =-50 μA		2.9	3.0		2.9		
		4.5	I <sub>O</sub> =-50 μA		4.4	4.5		4.4		
		3.0	I <sub>O</sub> =-4 mA		2.58			2.48		
		4.5	I <sub>O</sub> =-8 mA		3.94			3.8		
V <sub>OL</sub>	Low Level Output Voltage	2.0	I <sub>O</sub> =50 μA			0.0	0.1		0.1	
		3.0	I <sub>O</sub> =50 μA			0.0	0.1		0.1	
		4.5	I <sub>O</sub> =50 μA			0.0	0.1		0.1	
		3.0	I <sub>O</sub> =4 mA				0.36		0.44	
		4.5	I <sub>O</sub> =8 mA				0.36		0.44	
I <sub>I</sub>	Input Leakage Current	0 to 5.5	V <sub>I</sub> = 5.5V or GND				±0.1		±1.0	μA
I <sub>CC</sub>	Quiescent Supply Current	5.5	V <sub>I</sub> = V <sub>CC</sub> or GND				2		20	μA

AC ELECTRICAL CHARACTERISTICS (Input t<sub>r</sub> = t<sub>f</sub> = 3 ns)

Symbol	Parameter	Test Condition			Value					Unit
					T <sub>A</sub> = 25 °C			-40 to 85 °C		
					V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min.	Typ.	Max.	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay Time	3.3 <sup>(*)</sup>	15			7.6	11.9	1.0	14.0	ns
		3.3 <sup>(*)</sup>	50			10.1	15.4	1.0	17.5	
		5.0 <sup>(**)</sup>	15			4.9	7.7	1.0	9.0	
		5.0 <sup>(**)</sup>	50			6.4	9.7	1.0	11.0	

(\*) Voltage range is 3.3V ± 0.3V

(\*\*) Voltage range is 5V ± 0.5V

## CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Test Conditions			Value					Unit
					T <sub>A</sub> = 25 °C			-40 to 85 °C		
					Min.	Typ.	Max.	Min.	Max.	
C <sub>IN</sub>	Input Capacitance				4	10			10	pF
C <sub>PD</sub>	Power Dissipation Capacitance (note 1)				16					pF

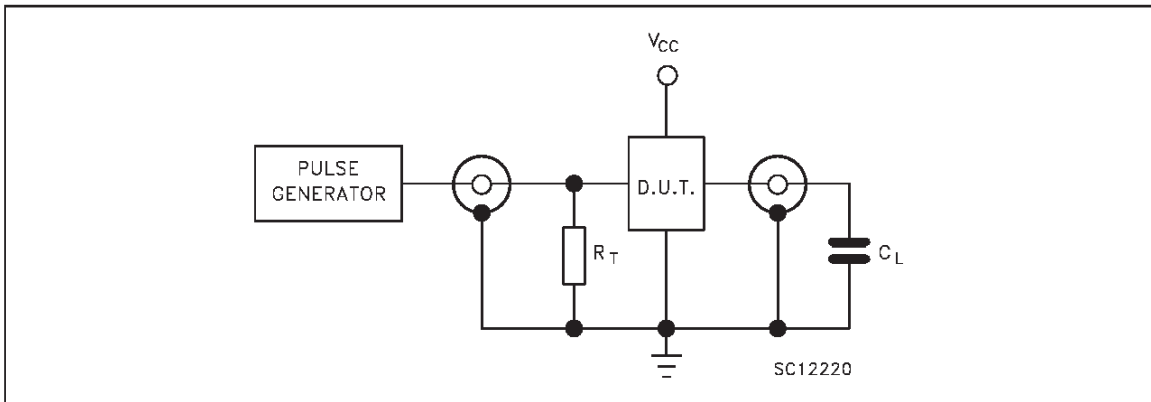
1) C<sub>PD</sub> is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average operating current can be obtained by the following equation. I<sub>CC(OPR)</sub> = C<sub>PD</sub> • V<sub>CC</sub> • f<sub>IN</sub> + I<sub>CC</sub>/4 (per Gate)

**DYNAMIC SWITCHING CHARACTERISTICS**

Symbol	Parameter	Test Conditions		Value					Unit
		V <sub>CC</sub> (V)	C <sub>L</sub> = 50 pF	T <sub>A</sub> = 25 °C			-40 to 85 °C		
				Min.	Typ.	Max.	Min.	Max.	
V <sub>OLP</sub>	Dynamic Low Voltage Quiet Output (note 1, 2)	5.0	C <sub>L</sub> = 50 pF		0.3	0.8			V
V <sub>OLV</sub>				-0.8	-0.3				
V <sub>IHD</sub>	Dynamic High Voltage Input (note 1, 3)	5.0		3.5					
V <sub>ILD</sub>	Dynamic Low Voltage Input (note 1, 3)	5.0				1.5			

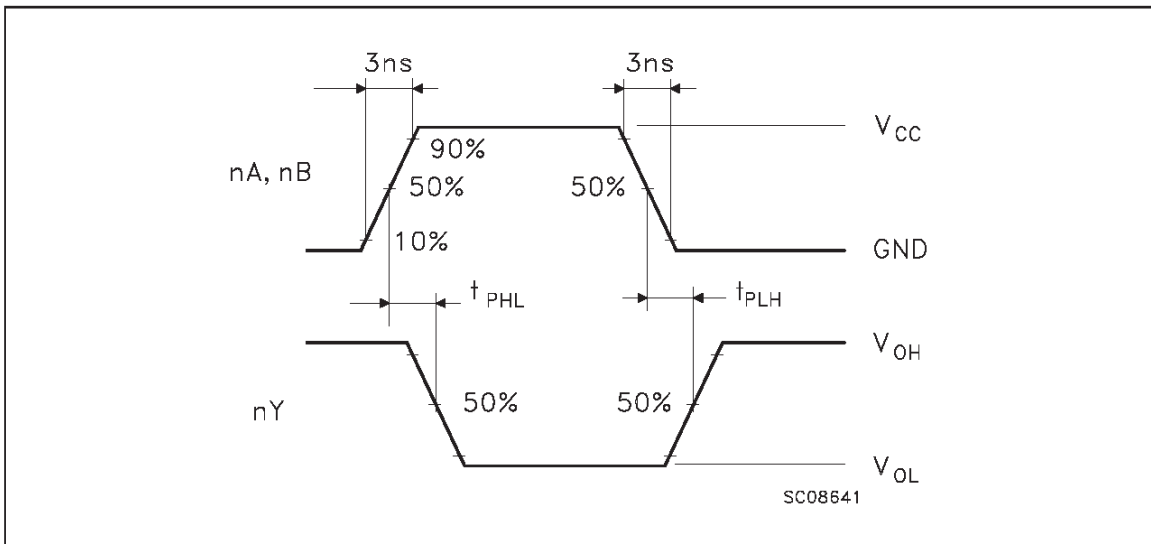
- 1) Worst case package.
- 2) Max number of outputs defined as (n). Data inputs are driven 0V to 5.0V, (n-1) outputs switching and one output at GND.
- 3) Max number of data inputs (n) switching. (n-1) switching 0V to 5.0V. Inputs under test switching: 5.0V to threshold (V<sub>ILD</sub>), 0V to threshold (V<sub>IHD</sub>), f=1MHz.

**TEST CIRCUIT**



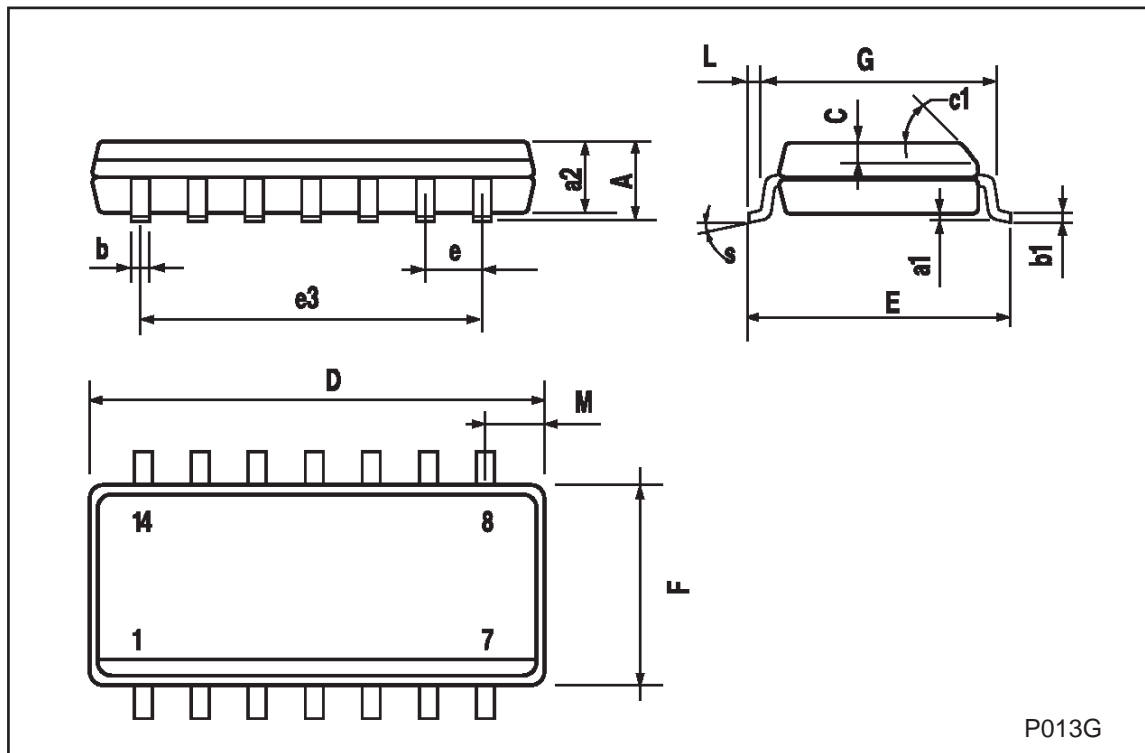
C<sub>L</sub> = 15/50 pF or equivalent (includes jig and probe capacitance)  
 R<sub>T</sub> = Z<sub>OUT</sub> of pulse generator (typically 50Ω)

**WAVEFORM: PROPAGATION DELAYS (f=1MHz; 50% duty cycle)**



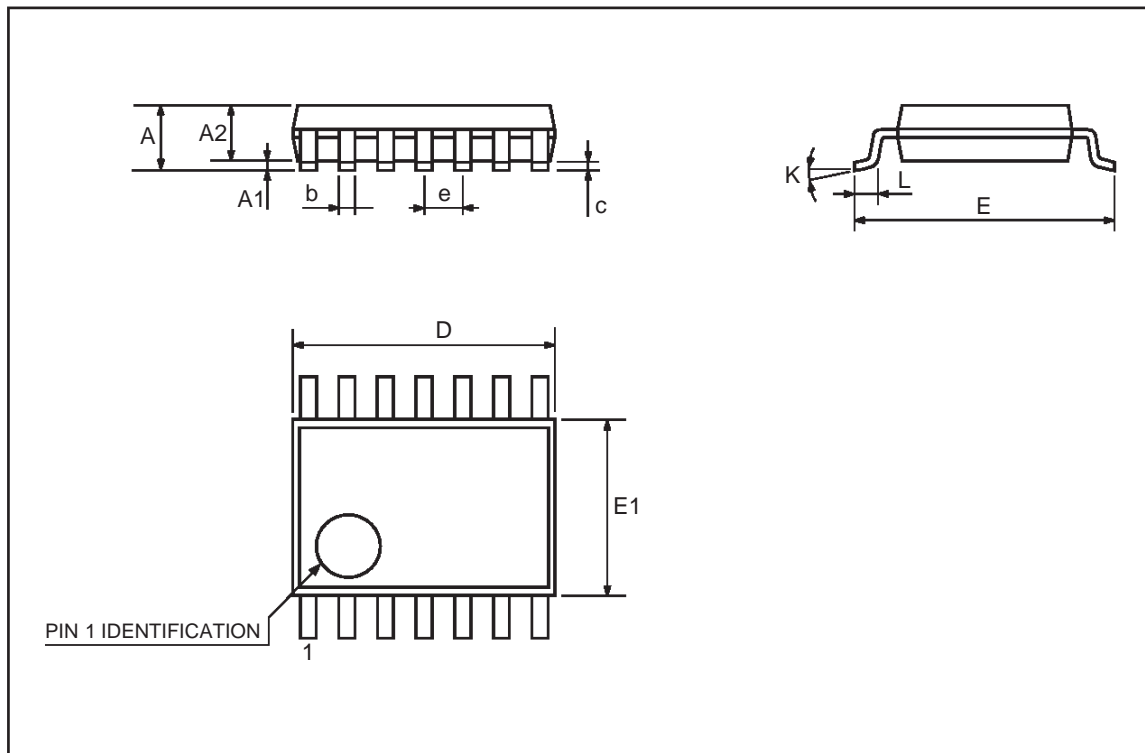
## SO-14 MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.75			0.068
a1	0.1		0.2	0.003		0.007
a2			1.65			0.064
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
C		0.5			0.019	
c1	45 (typ.)					
D	8.55		8.75	0.336		0.344
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		7.62			0.300	
F	3.8		4.0	0.149		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.019		0.050
M			0.68			0.026
S	8 (max.)					



## TSSOP14 MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.1			0.433
A1	0.05	0.10	0.15	0.002	0.004	0.006
A2	0.85	0.9	0.95	0.335	0.354	0.374
b	0.19		0.30	0.0075		0.0118
c	0.09		0.20	0.0035		0.0079
D	4.9	5	5.1	0.193	0.197	0.201
E	6.25	6.4	6.5	0.246	0.252	0.256
E1	4.3	4.4	4.48	0.169	0.173	0.176
e		0.65 BSC			0.0256 BSC	
K	0°	4°	8°	0°	4°	8°
L	0.50	0.60	0.70	0.020	0.024	0.028



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